

TRANSMITTAL

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Stylesheet Version v1.1.0

Title of Invention	[MOLD AND METHOD OF MOLDING SEMICONDUCTOR DEVICES]							
<p>Application Number :</p> <p>Date :</p> <p>First Named Applicant: Mr. Jen-Chieh Kao</p> <p>Confirmation Number:</p> <p>Attorney Docket Number: 11184-US-PA</p>								
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<table border="1"><thead><tr><th data-bbox="138 1046 813 1086">Submitted By:</th><th data-bbox="813 1046 1168 1086">Elec. Sign.</th><th data-bbox="1168 1046 1485 1086">Sign. Capacity</th></tr></thead><tbody><tr><td data-bbox="138 1086 813 1165">Dr. Belinda Lee Registered Number: 46,863</td><td data-bbox="813 1086 1168 1165">/Belinda Lee/</td><td data-bbox="1168 1086 1485 1165">Inventor</td></tr></tbody></table>			Submitted By:	Elec. Sign.	Sign. Capacity	Dr. Belinda Lee Registered Number: 46,863	/Belinda Lee/	Inventor
Submitted By:	Elec. Sign.	Sign. Capacity						
Dr. Belinda Lee Registered Number: 46,863	/Belinda Lee/	Inventor						

Documents being submitted:	Files
us-fee-sheet	11184-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-assignment	11184-usassn.xml us-assignment.xsl us-assignment.dtd 11184assignment1.tif 11184assignment2.tif
us-request	11184-usrequ.xml us-request.dtd us-request.xsl
us-declaration	11184declaration1.tif
us-declaration	11184declaration2.tif
application-body	11184-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd 11184us0001.tif 11184us0002.tif 11184us0003.tif 11184us0004.tif 11184us0005.tif 11184us0006.tif 11184us0007.tif 11184us0008.tif

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Comments

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